

Electronic Patent Application Fee Transmittal

Application Number:	10551745			
Filing Date:	19-Mar-2007			
Title of Invention:	Diffusion Soldered Semiconductor Device and Method			
First Named Inventor/Applicant Name:	Edmund Riedl			
Filer:	Mark L. Gleason/Katy Henry			
Attorney Docket Number:	I431.131.101/FIN 421 PCT/			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1615	2	52	104
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				104